



TXC CORPORATION

4F, NO. 16, Sec. 2 Chung Yang S Rd., Peitou, Taipei, Taiwan.

TEL : 886-2-2894-1202 , 886-2-2895-2201 FAX : 886-2-2894-1206 , 886-2-2895-6207

www.txccorp.com

SPECIFICATION FOR APPROVAL

CN: 1312001671

CUSTOMER	:	
PRODUCT TYPE	:	SMD GLASS SEALING XTAL 5.0*3.2
NOMINAL FREQ.	:	8.000000MHz
TXC P/N	:	AA08000016
REVISION	:	S1
CUSTOMER P/N	:	
PM / SALES	:	
DATE	:	
CUSTOMER SIGNATURE & Date		

- (1) TxC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TxC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

MSL:Level 1
RoHS Compliant

Pb used in sealing glass material is exempt from EU directive



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PRODUCT SPECIFICATION SHEET

CN: 1312001671

PRODUCT TYPE : SMD GLASS SEALING XTAL 5.0*3.2

NOMINAL FREQ. : 8.000000MHz

TXC P/N : AA08000016

REVISION : S1

PE/RD	QA	MFG
<i>Shih-Yung Pao</i> Shih-Yung Pao		
<i>31-Dec-13</i>		

NOTE:

- (1)Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).
- (2)Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3)Revision "Ax" is production ready. PE, QA and MFG's approval required

MSL:Level 1
RoHS Compliant

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[illegible]



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■ ELECTRICAL SPECIFICATIONS

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature : 25±5°C

Relative humidity : 40%~70%

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature : 25±3°C

Relative humidity : 40%~70%

Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

Crystal cutting type

The crystal is using AT CUT (thickness shear mode).

Unit Weight:

0.054±0.005 g/pcs

	Parameters	SYM.	Electrical Spec.				Notes
			MIN	TYP	MAX	UNITS	
1	Nominal Frequency	FL	8.000000			MHz	-
2	Oscillation Mode	-	Fundamental			-	-
3	Load Capacitance	CL	18			pF	-
4	Frequency Tolerance	-	±30			ppm	at 25 °C ± 3 °C
5	Frequency Stability	-	±40			ppm	Over Operating Temp. Range (Reference 25°C)
6	Operating Temperature	-	-40	~	85	°C	-
7	Aging	-	±3			ppm	1st Year
8	Drive Level	DL	-	100	-	uW	-
9	Effective Resistance Rr	Rr	-	-	150	Ω	-
10	Shunt Capacitance C0	C0	-	-	5	pF	-
11	Insulation Resistance	-	500	-	-	MΩ	at DC 100V
12	Storage Temperature Range	-	-40	~	105	°C	-

■ FACTORY LOCATION

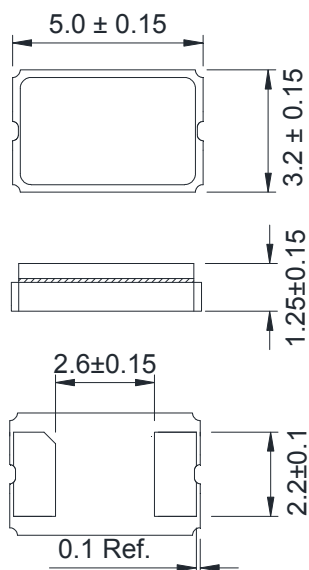
TXC (NINGBO) CORPORATION

NO.189 Huang Shan West Road, Beilun District,

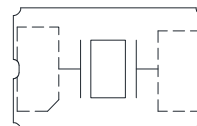
Ningbo Zhejiang China

DIMENSIONS

(Unit:mm)



Connection

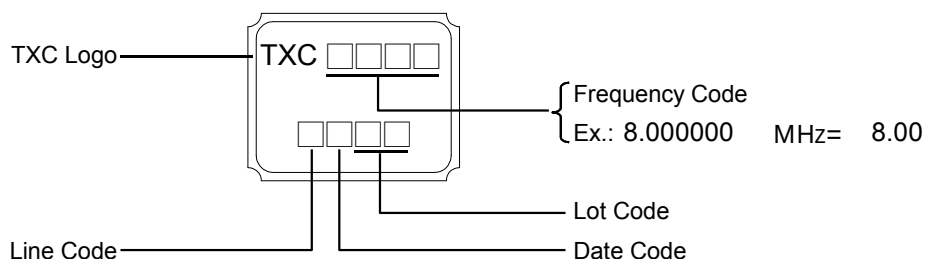


Suggested Layout



*Coplanarity of solderable areas Camber 0.10 mm Max

MARKING



Date Code:

YEAR				MONTH											
				JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2005	2009	2013	2017	A	B	C	D	E	F	G	H	J	K	L	M
2006	2010	2014	2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2007	2011	2015	2019	a	b	c	d	e	f	g	h	j	k	l	m
2008	2012	2016	2020	n	p	q	r	s	t	u	v	w	x	y	z

*This date code will be cycled every four years

SUGGESTED REFLOW PROFILE

Solder melting point : 220 ± 10 °C , 60 sec. Min

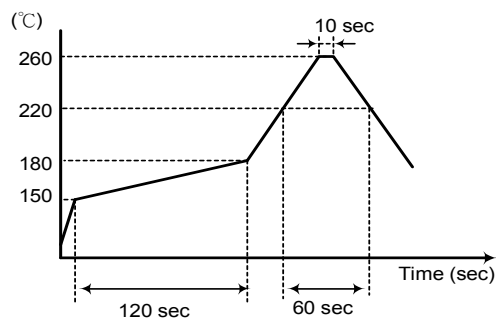
Peak Temperature: 260 ± 5 °C , 10 sec. Max.

SUGGESTED MANUAL SOLDER CONDITION

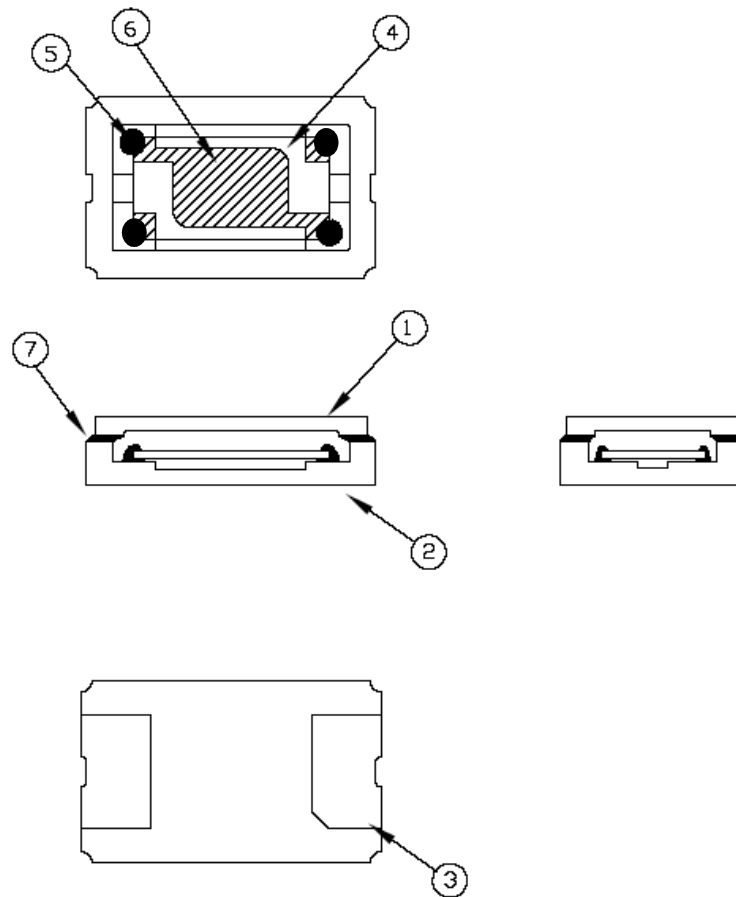
Temperature: 350 ± 10 °C

Time: 3 sec.

Re-solder times: twice

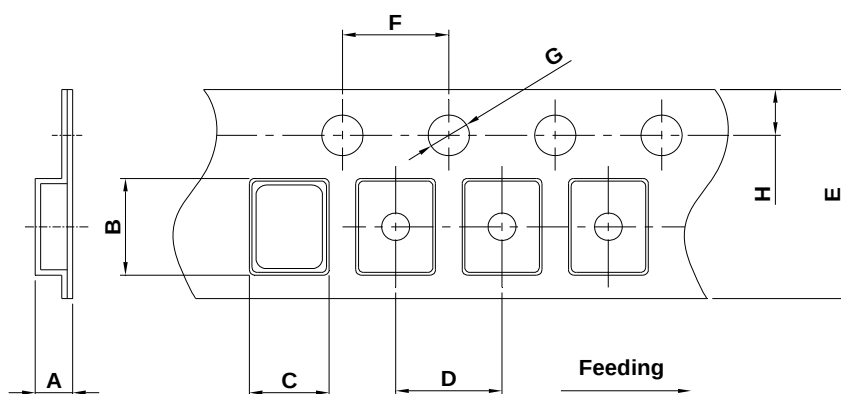


■ STRUCTURE ILLUSTRATION



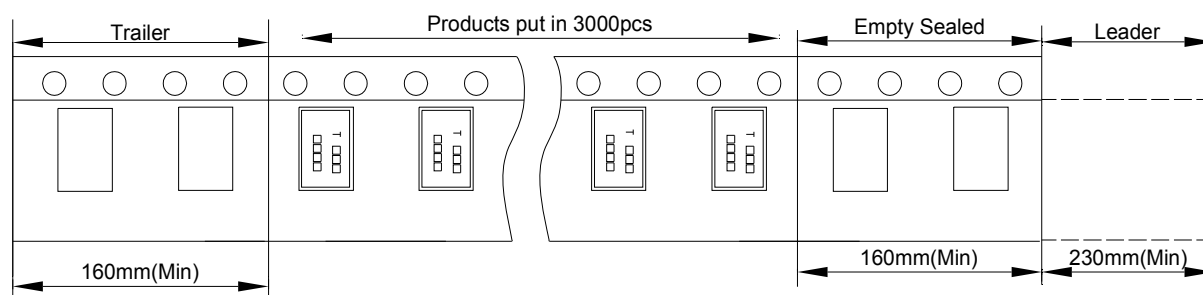
NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Cap	Ceramic (Al ₂ O ₃)	-
2	Base(Package)	Ceramic (Al ₂ O ₃)	-
3	PAD	Au	Tungsten metalize + Ni plating + Au plating
4	Crystal blank	SiO ₂	-
5	Conductive adhesive	Resin+Ag	-
6	Electrode	Noble Metal	-
7	Sealing Glass	Glass(PbO)	-

■ EMOSS CARRIER TAPE & REEL

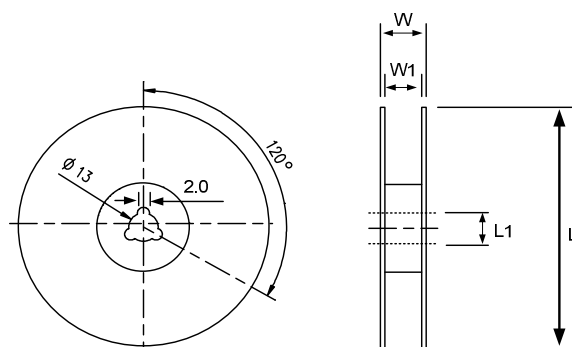


DIMENSIONS	A	B	C	D	E	F	G	H	
	1.65±0.10	5.40±0.10	3.50±0.10	8.00±0.10	12.00±0.30	4.00±0.10	1.55±0.10	1.75±0.10	(UNIT : mm)

REMARK :



User direction of feed



DIMENSIONS	L	L1	W	W1	
	180±1.00	13±0.50	16.5±0.20	12±0.10	(UNIT : mm)

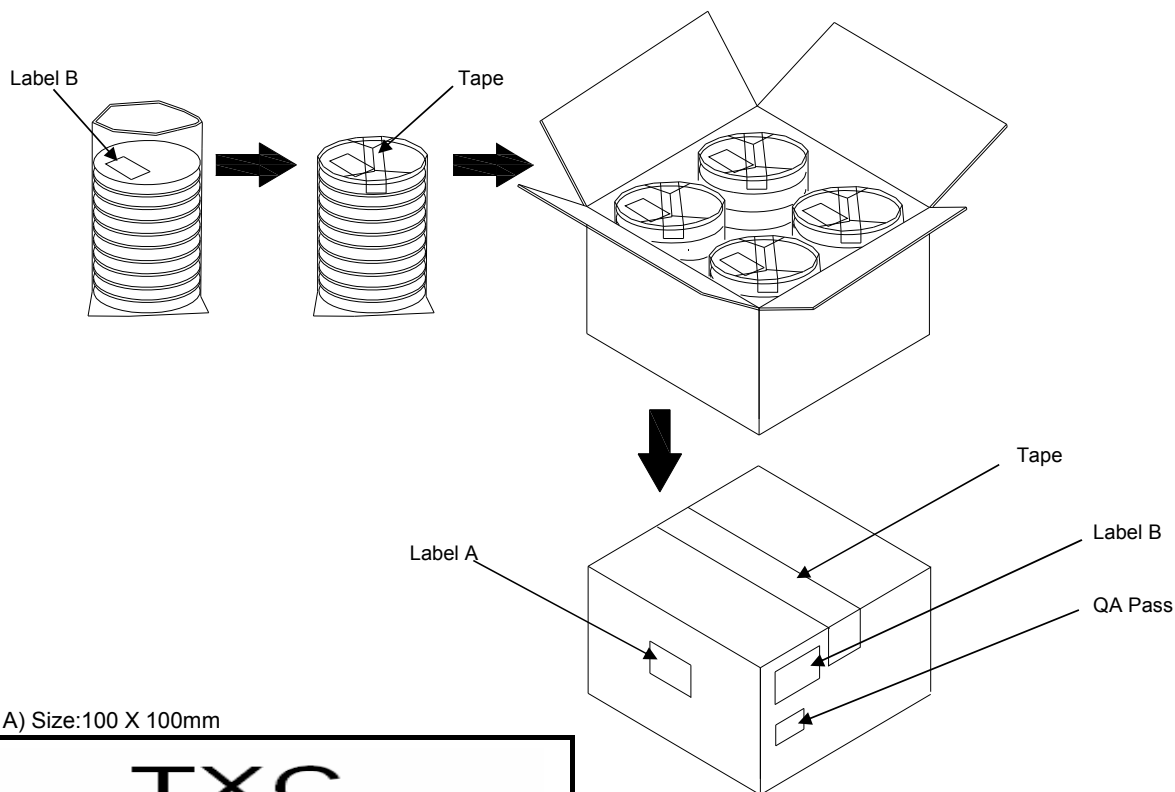
■ PACKING

Reel Quantity :

1. Reel X 5 (5 Reels x1)
2. Reel X 10 (10 Reels x1)
3. Reel X 20 (10 Reels x2)
4. Reel X 40 (10 Reels x4)

Box Size:

1. L200 X W200 X H140mm
2. L200 X W200 X H250mm
3. L400 X W200 X H250mm
4. L400 X W400 X H280mm



(Label A) Size:100 X 100mm

TXC	
Inv No: 00096815	
Po No: 21106326- 24- 1	
Part No: 	
Q'ty: 40000 PCS	
C/No: 157- 44	

(Label B) Size:80 X 40mm

TXC CORPORATION		QA PASS
DATE CODE:	QTY:	2011/09/02
1000		
LOT NO:	RoHS	
PART NO:	HF	
FREQ:		

[STORAGE]

- 1.The storage time to be 1 year maximum.
- 2.Don't be caught in the rain.
- 3.The storage environment shall be 5℃ ~40℃ temperature and 30% ~ 75%RH humidity and free from the sun shine.
- 4.If customers have special requirements, we can paste labels according to it.

■ RELIABILITY SPECIFICATIONS (AEC-Q200 Compliant)

1.Mechanical Endurance

No.	Test Item	Test Methods	Test Criteria
1.1	Mechanical Shock	2000 G , 0.3 m Sec. ,3 times for all 3 directions.	B C
1.2	Vibration	Frequency range 10 ~ 2000 Hz Acceleration 20G Amplitude 1.52mm Sweep time 20 minute Pendicular axes each test time 4 hours (Total test time 12 hours)	B C
1.3	Terminal Strength	17.7N force for 60sec +/-1sec.	F
1.4	Board Flex	Duration time:60 Sec Minimum,Deviation:3mm	B C
1.5	Solderability	Temperature 245 °C +/- 5°C Immersing depth 0.5 mm minimum Immersion time 5 +/- 0.5 seconds Flux Rosin resin methyl alcohol solvent (1 : 4)	E

2.Environmental Endurance

No.	Test Item	Test Methods	SPEC
2.1	Resistance To Soldering Heat	Test temperature 260 +/- 5 °C Test time 10 +/- 1 sec.	BCD
2.2	High Temp. Storage	+ 85°C ± 3 °C for 1000 ± 12 Hrs	BCD
2.3	Low Temp. Storage	- 40 °C ± 3 °C for 1000 ± 12 Hrs	BCD
2.4	Temperature cycle	-40°C~105°C,for 1000 cycles. 	BCD
2.5	Operational Life	1000 hrs @ 85± 3°C. Rated VDD applied with 1 MΩ.	BCD
2.6	High Temp&Humidity	85°C ± 3°C , RH 85% , 1000 Hrs	BCD

RELIABILITY SPECIFICATIONS

Specifications	
A	Frequency change: Within $\pm 5\text{ppm}$ or in customer's specification.
B	Frequency change: Within $\pm 10\text{ppm}$ or in customer's specification.
C	Equivalent series resistance(E.S.R) change: Within $\pm 15\%$ or 10Ω (larger value).
D	After conditioning , quartz crystal units shall be subjected to standard atmospheric conditions for 24 hour, and measured.
E	Minimum 95% of immersed terminal shall be covered with new uniform solder.
F	No damage on specimen

Measurement condition

Electrical characteristics measured by S&A250B or equivalent.